TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK3453

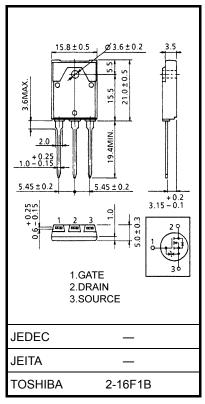
Switching Regulator Applications

Unit: mm

- Low drain-source ON resistance: RDS (ON) = 0.72Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 7.0 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = 100 \mu A \text{ (max) (V}_{DS} = 700 \text{ V)}$
- Enhancement model: $V_{th} = 2.0 \sim 4.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA)}$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	700	V	
Drain-gate voltage (F	$R_{GS} = 20 \text{ k}\Omega$	V _{DGR}	700	V	
Gate-source voltage	_	V _{GSS}	±30	V	
Drain current	DC (Note 1	l _D	10	Α	
	Pulse (Note 1	I _{DP}	30		
Drain power dissipat	ion (Tc = 25°C)	PD	80	W	
Single pulse avalance	he energy (Note 2)	E _{AR}	420	mJ	
Avalanche current		I _{AR}	10	Α	
Repetitive avalanche	energy (Note 3	E _{AR}	8	mJ	
Channel temperature)	T _{ch}	150	°C	
Storage temperature	range	T _{stg}	-55~150	°C	



Weight: 5.8 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to case	R _{th (ch-c)}	1.56	°C/W	
Thermal resistance, channel to ambient	R _{th (ch-a)}	41.6	°C/W	

- Note 1: Ensure that the channel temperature does not exceed 150°C.
- Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 7.5 mH, $R_G = 25 \Omega$, $I_{AR} = 10 \text{ A}$
- Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.



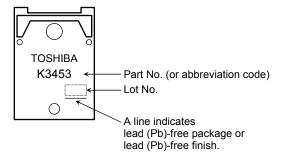
Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	te leakage current I_{GSS} $V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$		_	_	±10	μА	
Drain-source brea	akdown voltage	V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	V
Drain cut-OFF cu	rrent	I _{DSS}	V _{DS} = 700 V, V _{GS} = 0 V	_	_	100	μА
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	700	_	_	V
Gate threshold voltage		V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	V
Drain-source ON resistance		R _{DS} (ON)	V _{GS} = 10 V, I _D = 5 A	_	0.72	1.0	Ω
Forward transfer	admittance	Yfs	V _{DS} = 10 V, I _D = 5 A	4.0	7.0	_	S
Input capacitance		C _{iss}		_	1700	_	pF
Reverse transfer capacitance		C _{rss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	40	_	
Output capacitance		C _{oss}			200	_	
Switching time	Rise time	t _r	$V_{GS} = 0 \text{ V}$ $V_{GS} = 0 \text{ V}$ $V_{DD} = 200 \text{ V}$ $V_{DD} = 200 \text{ V}$ $V_{DD} = 200 \text{ V}$	_	40		- ns
	Turn-ON time	t _{on}		_	72	_	
	Fall time	t _f		_	42	_	
	Turn-OFF time	t _{off}		_	145	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	_	53	_	nC
Gate-source charge		Q _{gs}		_	25	_	
Gate-drain ("miller") charge		Q _{gd}		_	28	_	

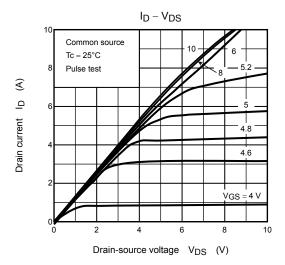
Source-Drain Ratings and Characteristics (Ta = 25°C)

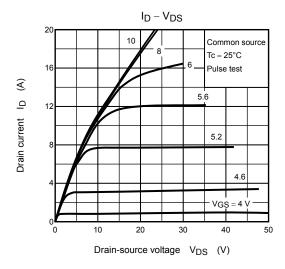
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	_	_	_	10	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	30	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 10 A, V _{GS} = 0 V	_	_	-1.9	V
Reverse recovery time	t _{rr}	I _{DR} = 10 A, V _{GS} = 0 V,	_	1400	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 100 A/μs	_	17.5	_	μС

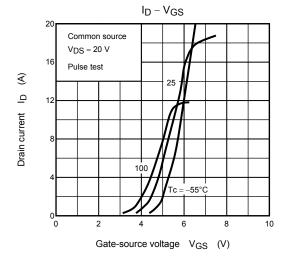
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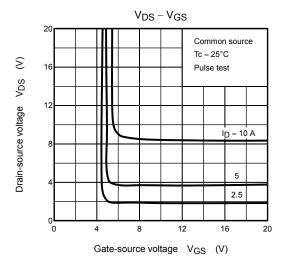


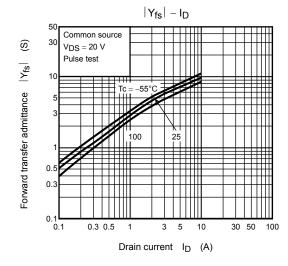
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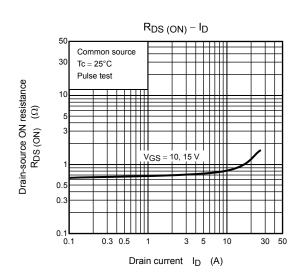




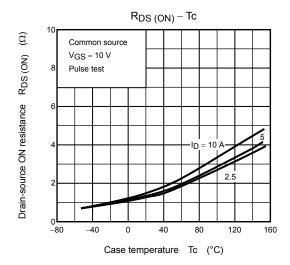


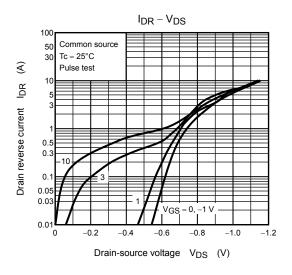


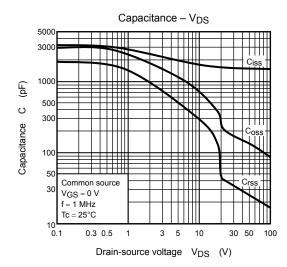


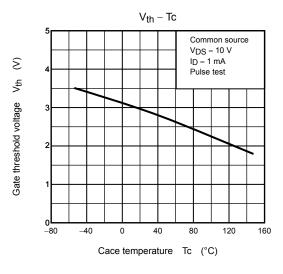


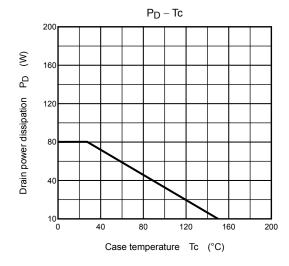
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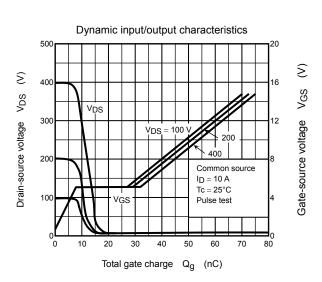


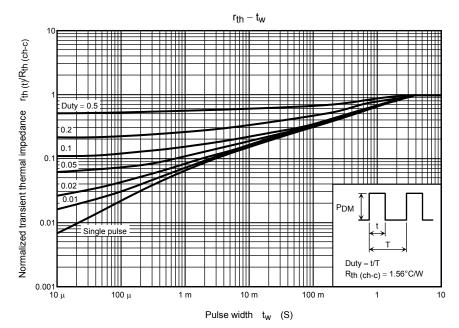


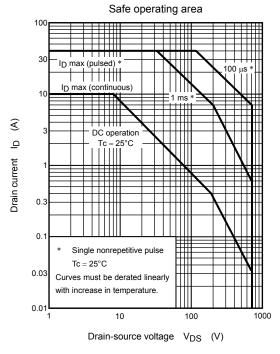


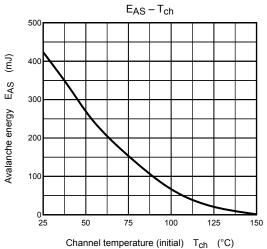


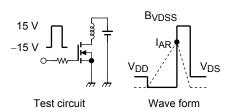












$$R_G = 25 \Omega$$

 $V_{DD} = 90 \text{ V, L} = 7.5 \text{ mH}$

$$EAS = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS - VDD} \right)$$

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